

## PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT3051511

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
KAZUO OGATA	08/10/2006
TSUYOSHI FUKUO	08/10/2006
SEIJI ISHIYAMA	08/10/2006
TETSUhide KOH	08/10/2006
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<b>Postal Code:</b>	95054
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	11479633
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<b>NAME OF SUBMITTER:</b>	LEE WOLFE
<b>SIGNATURE:</b>	/Lee Wolfe/
<b>DATE SIGNED:</b>	10/03/2014
<b>Total Attachments: 2</b>	
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5/29/06

Attorney Docket No.: P24212

**ASSIGNMENT**

7054,198

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

**Kazuo Ogata; Tsuyoshi Fukuo; Seiji Ishiyama; Tetsuhide Koh**

hereby sell, assign, and transfer to:

**Intel Corporation**

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95052 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all inventions and improvements that are disclosed in the application for the United States patent entitled:

**Flexible Joint Methodology to Attach a Die on an Organic Substrate**

the Declaration for which has been executed by the undersigned prior hereto or concurrently herewith, said patent application which can also be identified as follows (if necessary):

(I hereby authorize and request my attorney, associated with Customer Number 45209, to insert on the designated lines below, the filing date and application number of said application when known.)

United States Patent Application Number 11/479,633 filed on June 29, 2006

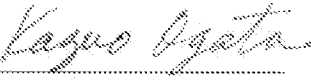
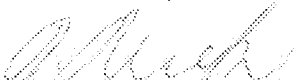
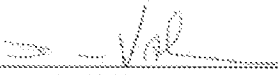
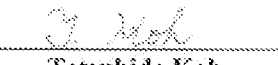
and in and to said application (nonprovisional or provisional) and all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all nonprovisional applications claiming priority to said application, and all other patent applications that have been or shall be filed in the United States and all foreign countries on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all foreign countries on said inventions and improvements; and in and to all rights of priority resulting from the filing of said United States applications;

agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and

improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Each Inventor please sign and Date below

 Kazuo Ogata	8/10/06 (Today's Date)
 Tsuyoshi Fukuo	8/10/06 (Today's Date)
 Seiji Ishiyama	8/10/06 (Today's Date)
 Tetsuhide Koh	8/10/06 (Today's Date)